Tyrone Camarero Specifications



Camarero DS300TTP-224-SIOM

Key features

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/v3 family
- Intel® C612 chipset
- Up to 2TB ECC 3DS LRDIMM, up to DDR4-2400 MHz; 16x DIMM slots
- 1 PCI-E 3.0 x16 (LP), 1 PCI-E 3.0 x8 (LP), 1 SIOM card support
- 1 Dedicated IPMI LAN port
- 6 Hot-swap 2.5" SATA3 drive bays
- 1 SATA DOM
- 2000W Redundant Power Supplies Platinum Level





Processor/Cache

Processor Dual socket R3 (LGA 2011) supports

Intel® Xeon® processor E5-2600v4/v3 family

Chipset

Chipset Intel® C612 chipset

System Memory

Memory Capacity 16x 288-pin DDR4 DIMM slots,

Up to 2TB ECC 3DS LRDIMM,

512 ECC RDIMM

Expansion Slots

PCI-Express 1x PCI-E 3.0 x16 Low-profile slot

and 1x "0 slot"

Integrated On-Board

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10

LAN 1 RJ45 Dedicated IPMI LAN port

Add-on Options

Raid Optional

Optical Drive None

Front Panel

LED Indicators Power status LED, HDD activity LED,

2x Network activity LEDs,

Universal Information (UID) LED

Buttons Power On/Off button, UID button

Drive Bays

HDD bays 6x 2.5" Hot-swap SAS/SATA HDD trays

Power Supply

2000W Redundant Power Supplies Platinum Level

Cooling System

4x 8cm heavy duty PWM fans with optimal fan speed control

Form Factor

Form Factor 2U Rackmount

 Height
 :
 3.47"(88mm),

 Width
 :
 17.25"(438mm),

 Depth
 :
 28.75"(730mm)

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For more/current product information, visit www.tyronesystems.com

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